

ANGI053059-P52

C-band matched GaN Device

Features:

Frequency: 5.3~5.9GHz

Saturated Output Power: Psat≥52dBm

PowerGain: Gain≥10dB Add-Efficiency: PAE≥45% Port Matching: Zin/Zout=50Ω

Description:

ANGI053059-P52 is an internal matching GaN device, which adopts advanced co-planar internal matching MCM and thin film circuit technology. The typical working frequency range is 5.3~5.9GHz. This device can be used in different RF/Microwave system and subsystem.

The high output power level, high efficiency and wide operating temperature range can make application very flexible.

Maximun Ratings (TC=25°C, Not recommended working under this condition):

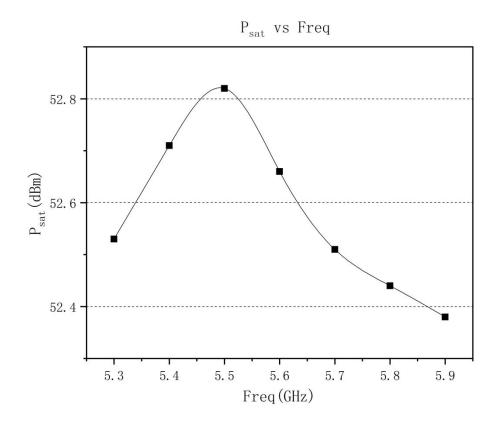
	Symbol	Value	Unit
Voltage between source and drain	V DS	40	V
Voltage between gate and source	V _G s	-5	V
Storage Temperature Range	T_{stg}	-65 to +175 °C	
Drain and Source Channel Temperature	Tch	175	°C



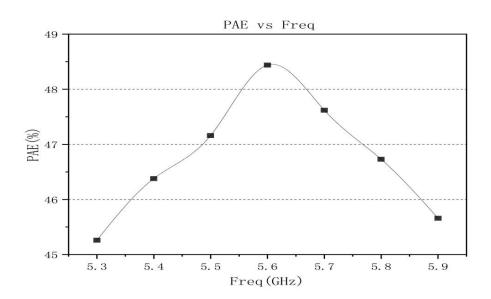
Electrical Characteristics:

			Value			
	Symbol	Test condition	Min	Тур	Max	Unit
Drain Current	Idsr	Vds=28V PW. T=1ms, Duty=10% Freq: 5.3~5.9GHz	-	11.4	-	Α
Saturated Output Power	Psat		52	-	-	dBm
Gain	Gp		10	-	-	dB
Add-Efficiency	PAE		45	-	-	%
Gain Flatness	ΔG		-0.8	-	+0.8	dB

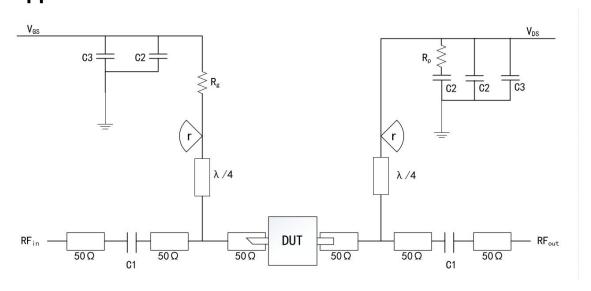
Typical Curve:



Internal Matching GaN Device



Application Circuit:



DUT: Device to be tested

C1:4.7pF R_p :51 Ω

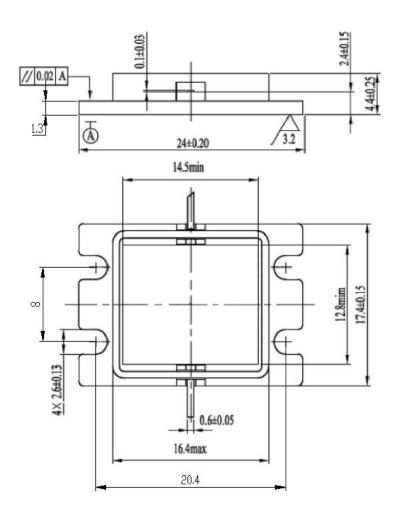
C2:1000pF R_G :15 Ω

C3:100uF r(radius)≈5.8mm(Rogers5880, 20mil)



ESD Level:

Outline:



Precautions for use:

- Pay attention to drying transportation and storage.
- Pay attention to anti-static during chip use and assembly, and wear grounding anti-static bracelet.
- When powering up, first apply grid power then add leakage.